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# FAIRCHILD

SEMICONDUCTOR TM

# **FQPF44N10 100V N-Channel MOSFET**

### **General Description**

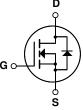
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

# **Features**

- 27A, 100V,  $R_{DS(on)} = 0.039\Omega @V_{GS} = 10 V$  Low gate charge ( typical 48 nC)
- Low Crss (typical 85 pF) •
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating





# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQPF44N10	Units
V <sub>DSS</sub>	Drain-Source Voltage		100	V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ ) - Continuous ( $T_C = 100^{\circ}C$ )		27	А
			19.1	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	108	A
V <sub>GSS</sub>	Gate-Source Voltage		± 25	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	530	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	27	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	5.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
PD	Power Dissipation ( $T_C = 25^{\circ}C$ )		55	W
	- Derate above 25°C		0.37	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

# **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case		2.73	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

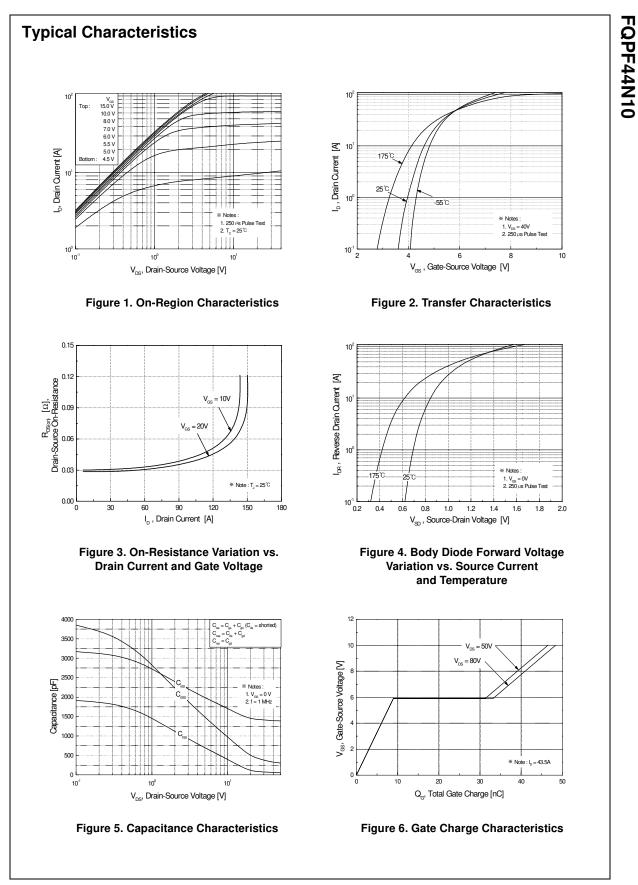
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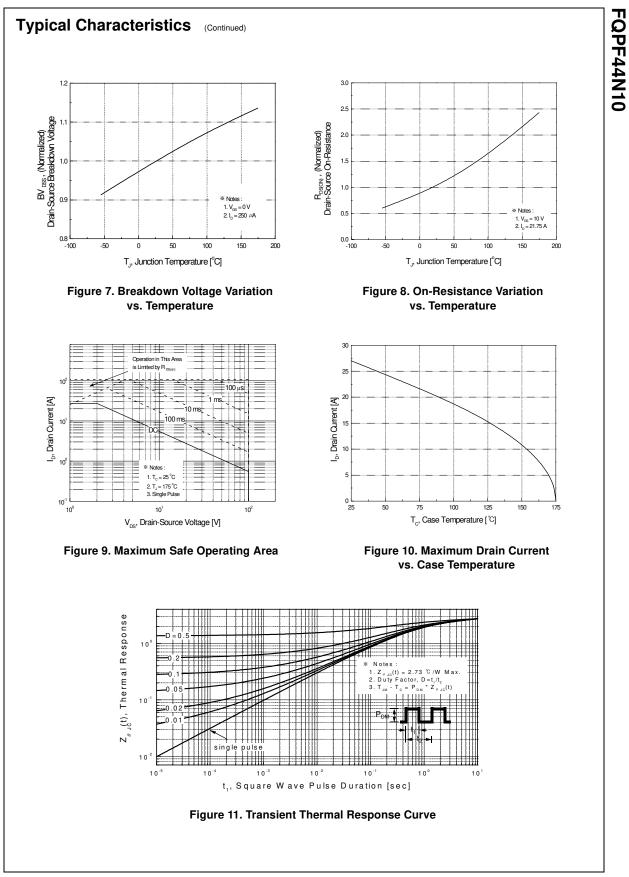
-	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	100			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25	5°C	0.1		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	μA
		$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$			10	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS}$ = -25 V, $V_{DS}$ = 0 V			-100	nA
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13.5 A		0.03	0.039	Ω
9fs	Forward Transconductance	$V_{DS} = 40 \text{ V}, I_D = 13.5 \text{ A}$ (Not	e 4)	26		S
Dynam C <sub>iss</sub>	ic Characteristics	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,		1400	1800	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		425	550	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			85	110	pF
Switch	ing Characteristics			1		
t <sub>d(on)</sub>	Turn-On Delay Time			19	45	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 43.5 \text{ A},$		190	390	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> = 25 Ω		90	190	ns
u(011)	Turn-Off Fall Time	(Note	4, 5)	100	210	ns
t <sub>f</sub>						
	Total Gate Charge	$V_{DC} = 80 \text{ V}$ $I_{D} = 43.5 \text{ A}$		48	62	nC
Qg		V <sub>DS</sub> = 80 V, I <sub>D</sub> = 43.5 A, V <sub>GS</sub> = 10 V		48 9.0	62 	nC nC
Q <sub>g</sub> Q <sub>gs</sub>	Total Gate Charge	$V_{DS}$ = 80 V, I <sub>D</sub> = 43.5 A, $V_{GS}$ = 10 V (Note		-		
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V <sub>GS</sub> = 10 V (Note		9.0		nC
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics ar	V <sub>GS</sub> = 10 V (Note	4, 5)	9.0 24		nC nC
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Dio	V <sub>GS</sub> = 10 V (Note <b>nd Maximum Ratings</b> ode Forward Current		9.0	  27	nC nC A
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Diode Maximum Pulsed Drain-Source Diode F	V <sub>GS</sub> = 10 V (Note <b>nd Maximum Ratings</b> ode Forward Current Forward Current	4, 5)	9.0 24	  27 108	nC nC
I <sub>S</sub>	Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Dio	V <sub>GS</sub> = 10 V (Note <b>nd Maximum Ratings</b> ode Forward Current	4, 5)	9.0 24  	  27	nC nC A A

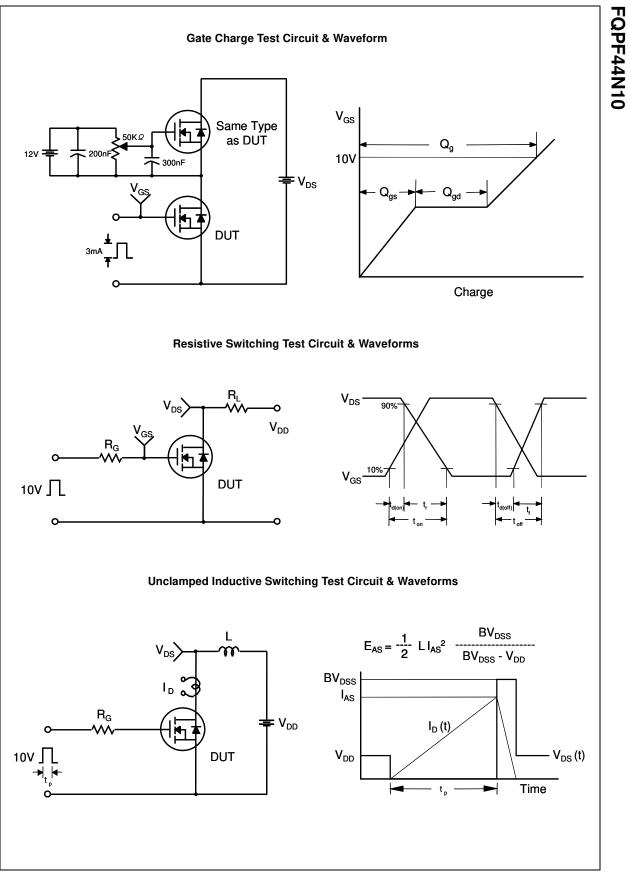
**Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 1.09mH,  $|_{AS} = 27A$ ,  $V_{DD} = 25V$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^{\circ}C$ 3.  $|_{SD} \le 43.5A$ ,  $di/dt \le 300A/\mu$ s,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 4. Pulse Test : Pulse width  $\le 300\mu$ s, Duty cycle  $\le 2\%$ 5. Essentially independent of operating temperature

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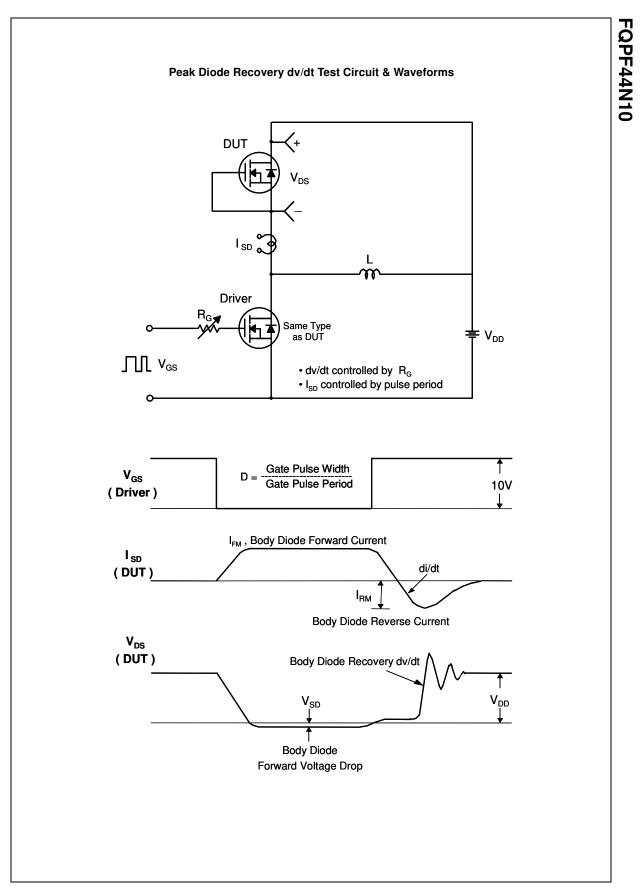


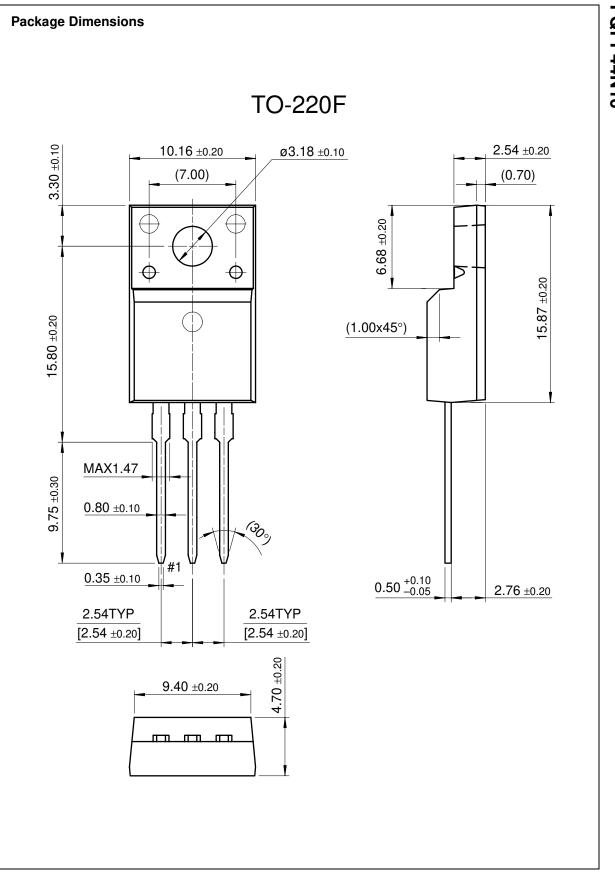
Rev. A2, December 2000





Rev. A2, December 2000





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# **PRODUCT STATUS DEFINITIONS**

#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
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